



Customer Information Notification

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Management Summary

The datasheet of the TJA1048 is updated, to clarify soldering of the HVSON package.

Datasheet update TJA1048

Information Notification

The HVSON version of the TJA1048 has recently been released. This package was already mentioned in the present datasheet. It was however not clearly mentioned in the datasheet that the exposed die-pad of the HVSON package should be soldered to board ground.

This has now been clearly described on page 4 of the updated version of this datasheet.

Why do we issue this Information Notification

These changes are made to ensure the correct information is in the TJA1048 datasheet.

Identification of Affected Products

Product identification does not change

Impact

There is no impact to the product's functionality.

Data Sheet Revision

A new datasheet will be issued

Disposition of Old Products

Not applicable, as nothing changes to the product.

Remarks

Please use the link 'view this notification online' at the top of this message under the heading 'Customer Information Notification' to log in to the NXP e-PCN system you're subscribed to, in order to obtain the attached datasheets from the tab 'Files'. The new datasheets will also be published shortly on the NXP internet (www.nxp.com).

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please [contact NXP "Global Quality Support Team"](#).

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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